



RE933-01

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for TSSOP 8
- Pitch: 0.65 mm (173 mil)
- Hole diameter 1.00 mm
- Size 8.89 x 23.50 mm

| Module-No. | Pitch | mil | Pin | Size (mm) |
|------------|----------|------|-----|-----------------|
| RE933-01 | 0.650 mm | 22.5 | 8 | 4.400 (173 mil) |